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In re patent of: Homma et al. Patent No: 5,747,427 Issued: May 5, 1998

For: Process For Forming A Semiconductor Thin Film Containing A Junction)

PATENT ASSIGNMENT COVER SHEET

January 31, 2000

D.C. 20231, on January 31, 2003

Commissioner for Patents Washington, D. C. 20231

Sir:

7. 1.12

January 31, 2003 Date:

Please record the attached original document or copy thereof. Total number of pages (with cover sheet): 2 Name of Conveying Party(ies): Name and Address of Party to Whom International Superconductivity Technology Center Correspondence Concerning Document Should be Mailed: 2a. Name and Address of Receiving Party(ies): Edward D. Manzo, Esq. Name: New Energy and Industrial Technology COOK, ALEX, McFARRON, MANZO, CUMMINGS & **Development Organization** MEHLER, LTD. Address: 1-1, Higashi Ikebukuro 3-chome, Toshima-ku 200 West Adams Street, Suite 2850 Chicago, Illinois 60606 Tokyo Japan Total Number of Applications and Patents 2b. Name and Address of Receiving Party(ies): Name: Involved: 1 Address 7. Total Fee (37 CFR 3.41): \$40.00° 7a. X Enclosed 3. Nature of Conveyance 7b. X Authorized to be Charged to Deposit X Assignment Account For Any Deficiency \_\_Merger Deposit Account Number: 50/1039 \_Security Agreement \_Change of Name (A duplicate copy of this page is attached) Other X Execution Date: 12/17/02; 1/14/03 Statement and Signature: To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a Application Number(s) or Patent number(s) (If this document is being filed together with a new application, true copy of the original document. the execution date of the application is:\_\_\_\_\_) 4a. Patent Application No.(s) Mark J. Murphy Name of Person Signing 4b. Patent No.(s) 5,747,427 Date: January 30, 2003

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REEL: 013727 FRAME: 8603

## ASSIGNMENT

Whereas, International Superconductivity Technology Center, a Japanese corporation, having its principal office and place of business at 34-3, Shinbashi 5-chome, Minato-ku, Tokyo Japan (hereinafter "Assignor") is the owner by assignment of the entire right, title and interest throughout the world in U.S. patent no 5,747,427 (hereinafter the "'427 patent"); and

Whereas, New Energy and Industrial Technology Development Organization, a Japanese corporation, having its principal office and place of business at 1-1, Higashi Ikebukuro 3-chome, Toshimaku Tokyo, Japan (hereinafter "Assignee") is desirous of acquiring or confirming its acquisition of 50% of the right, title and interest in and to said '427 patent, and to and under Letters Patent, which may be obtained from said patent, as hereinafter more fully set forth;

Assignor assigns 50% of its right, title and interest in said '427 patent or improvements disclosed in the patent and any and alf other applications for United States Letters Patent and foreign patents which may be filed on said '427 patent or improvements, including all continuations, divisionals, and continuations-in-part, and in any and all United States Letters Patent which may be obtained on any of said applications, and in any reissue or extension thereof.

Consideration Received. This assignment is made for good and valuable consideration of which Assignor acknowledges the receipt and sufficiency of the consideration.

Further Acts. Assignor agrees, upon the request and at the expense of the Assignee, to execute any divisional, continuation or substitute application for the invention or improvements, and any oath, declaration or affidavit relating thereto, and any application for the reissue or extension of any Letters Patent that may be granted upon the application. Assignor agrees to perform, upon request, any affirmative acts to obtain said Letters Patent of the United States and to vest in the Assignee 50% of all rights therein, so that the Letters Patent will be held and enjoyed by the Assignor and the Assignee, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by Assignor if this assignment had not been made.

Interference. In the event that any application or Letters Patent that I now assign becomes involved in interference, Assignor agrees to cooperate to the best of its ability in the matters of preparing and executing the preliminary statement and giving and producing evidence in support thereof.

IN TESTIMONY WHEREOF, said Assignor has hereunto set its hand and affixed its seal.

Name: Shoji/Tanaka Dec. 17, 2002

Date Title: Vice-President

IN TESTIMONY WHEREOF, said Assignee has hereunto set its hand and affixed its seal.

ame: Tsutomu Makino

**RECORDED: 02/07/2003** 

Maklor Jan 14. 2003\_ kino Date

Title: Chairman

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